# LNJ426W83RA1

### Surface Mounting Chip LED

#### UTSS Type

#### Absolute Maximum Ratings $T_a = 25^{\circ}C$

| Parameter                     | Symbol           | Rating      | Unit |  |
|-------------------------------|------------------|-------------|------|--|
| Power dissipation             | P <sub>D</sub>   | 40          | mW   |  |
| Forward current               | I <sub>F</sub>   | 15          | mA   |  |
| Pulse forward current *       | I <sub>FP</sub>  | 40          | mA   |  |
| Reverse voltage               | V <sub>R</sub>   | 4           | V    |  |
| Operating ambient temperature | T <sub>opr</sub> | -30 to +85  | °C   |  |
| Storage temperature           | T <sub>stg</sub> | -40 to +100 | °C   |  |

Lighting Color

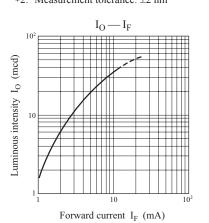
• Amber

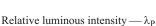
Note) \*: The condition of IFP is duty 10%, Pulse width 1 msec.

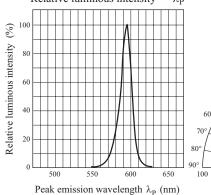
#### Electro-Optical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

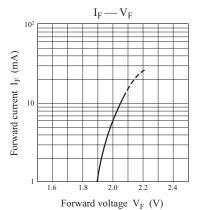
| Parameter                       | Symbol            | Conditions            | Min  | Тур  | Max   | Unit |
|---------------------------------|-------------------|-----------------------|------|------|-------|------|
| Luminous intensity *1           | I <sub>O</sub>    | $I_F = 10 \text{ mA}$ | 12.0 | 35.0 | 102.0 | mcd  |
| Reverse current                 | I <sub>R</sub>    | $V_R = 4 V$           |      |      | 100   | μΑ   |
| Forward voltage                 | V <sub>F</sub>    | $I_F = 10 \text{ mA}$ |      | 2.05 | 2.5   | V    |
| Peak emission wavelength        | $\lambda_{\rm P}$ | $I_F = 10 \text{ mA}$ |      | 595  |       | nm   |
| Dominant emission wavelength *2 | $\lambda_d$       | $I_F = 10 \text{ mA}$ | 585  | 589  | 596   | nm   |
| Spectral half band width        | Δλ                | $I_F = 10 \text{ mA}$ |      | 15   |       | nm   |

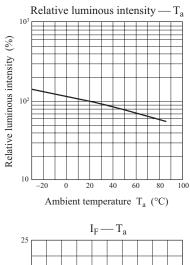
Note) \*1: Measurement tolerance: ±20% \*2: Measurement tolerance: ±2 nm

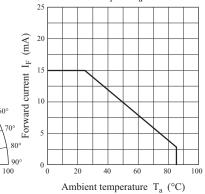












20 0 Relative luminous intensity (%)

20 40 60 80

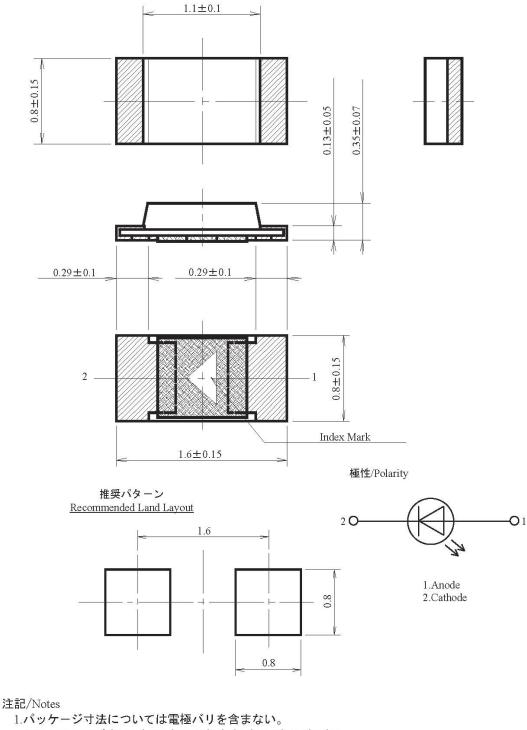
Directive characteristics

09

60

80 60 40

#### Package (Unit: mm)



Measurement of the package doesn't include electrode projection.

2.単位:mm/Unit:mm

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